Semiconductor WEEK:

September 9, 2022

An overview of results and conclusions from recent reports at TechInsights

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Chip Market Research Services

Temperatures are cooling amid rising uncertainty...

- Order activity for semiconductor equipment slipped to 82 degrees
- IC Inventory Levels •

Semiconductor Analytics

Last Week in the Semiconductor Market:

Semiconductor sales dipped 6% below 2021 levels last week, as the IC weather cooled 1°F to Chilly conditions. Zooming in on DRAMs this week, the 13-wk growth MA dropped to -13% Y/Y, falling off last year's peak of +54% in October.

TechInsights forecasts it will slide to \$94B in 2022, with Y/Y growth of -2% that falls to -7% in 2023, which may be optimistic.

TechInsights' IC Supply/Demand metrics continued to weaken last week. More than Moore Foundry and OSAT fell to Glut, joining More Moore Foundry, DRAM, and NAND. Additionally, IDM slipped from Loose to Saturated. Analog and Power held at Balanced and Auto ICs are actually showing signs of additional tightness.

The early signs of a bottom in Electronics' Retail Prices have diminished.

Chip History Center People: Yan Borodovsky discusses what was happening in 2007 with DFM and Computational Lithography at Intel in this historic interview series.

People: Craig Barrett discusses how Intel turned manufacturing into the powerhouse it is today, in the first of this series with Dr. Barrett from 2006.

The Chip Insider

Strategy and Tactics: Gelsinger's Systems Foundry Business Model.

Semiconductor Stocks

- TechInsights' Semiconductor Stock Indices jumped this week
- Semiconductor Stock Index was led up by Silicon Laboratories
- Semiconductor Equipment Stock Index was led up by BESI
 - BESI was this week's top performer
- EDA Stock Index was led up by Ansys
- Electronics Materials Stock Index was led up by Entegris
 - All companies finished in positive territory
- Hottest Stocks: BESI, Entegris, Silicon Laboratories, ASM International, STMicroelectronics, and ASML

TechInsights

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2022 SIA AWARDS DINNER THURSDAY, NOVEMBER 17, 2022

SAN JOSE MARRIOTT 301 S MARKET ST, SAN JOSE, CA 95113 SIA Reception: 5-6:30 pm Dinner, Awards, Keynote: 6:30-8:30 pm After-Dinner Reception: 8:30-10 pm

NOYCE AWARD RECIPIENT

LIP-BU TAN

Executive Chairman and Former CEO Cadence Design Systems, Inc. Founder and Chairman Walden International Founding Managing Partner Walden Catalyst Ventures



KEYNOTE SPEAKER **JIM FARLEY**

President and CEO of Ford Motor Company





For more information about tickets and sponsorship opportunities please contact Sarah Ravi at <u>sravi@semiconductors.org</u>

www.semiconductors.org

The Chip Insider®'s Graphics File



Contact us to access more details

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August 2022

Temperatures are cooling amid rising uncertainty...

- Order activity for semiconductor equipment slipped to 82 degrees
- The memory market is now in the midst of a downturn due to a significant supply/demand imbalance
- TechInsights' Chip Price Performance Index
 extended its slump

Forecast as of August 2022:	2022	2023		
Semi Equipment (\$B):	\$ 139.4	\$ 132.3		
Sequential Change	9.9%	-5.1%		
Capacity Utilization:	96.2%	90.9%		
ICs (\$B):	\$ 529.1	\$ 507.7		
Sequential Change	7.5%	-4.0%		
IC Units (BU):	419.3	415.9		
Sequential Change	6.4%	-0.8%		
Electronics (\$B) :	\$ 2,622	\$ 2,517		
Sequential Change	1.9%	-4.0%		

TechInsights

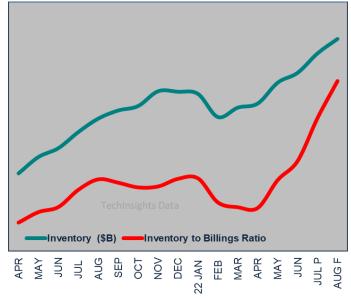
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The Chip Insider® Graphics

Semiconductor Inventory

Inventories continue to build up

IC Inventory Levels: chart gives rolling averages for semiconductor integrated circuit inventories held at OEMs and in Die Banks



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Insights Interview:

Workforce Development Solutions...

with Ajit Manocha of SEMI



What the conversation is about:

- Labor shortages have become the echo pandemic from the ravages COVID has had on the economy.
- This is no truer than in the semiconductor industry, where Workforce Development has long been on the To-Do lists of many.
- Most industry efforts appear to be more about lobbying others to do something about workforce development.
- It's really hard to do something substantive about it but SEMI is.

Click here to watch online



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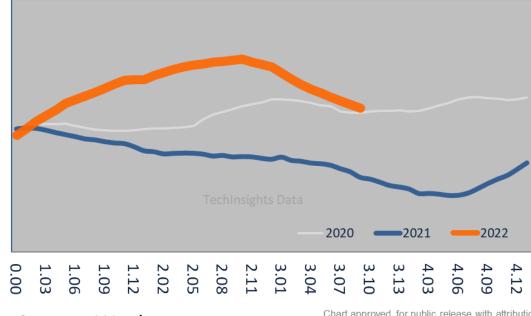
Electronics Retail Pricing Trends:

for PC notebooks Tablets Smartphones Cell phones Digital Cameras Appliances TVs

The early signs of a bottom in Electronics' Retail Prices have diminished.

Electronics Pricing Barometer

indexed 13 week moving average



Quarter.Week

Chart approved for public release with attribution. Copyright © TechInsights Inc. All rights reserved.

TechInsights

Source: Semiconductor Analytics

The Chip Insider® Strategy & Tactics

in

Strategy and Tactics: Gelsinger's Systems Foundry Business Model.

Summaries:

Gelsinger's Systems Foundry Business Model: The Foundry/IDM model is dead. Long live the Foundry model... In the beginning, there was the IDM model. The world didn't call it that at the time because there was no foundry model to contrast it with. To understand Pat's strategy, a refresher on the history of semiconductor business models may be helpful... So the industry shifts gear from Systems on Chip to Systems in Package, or Heterogeneous Integration, or Chiplets, or Disaggregated Design, or some other branding that depends more on who you're talking to than what they are actually doing. It's all the same destination, it's just that the industry has yet to settle on a common name. Whatever it's called, there is a decadal cadence to these business models that are causally driven by the cadence of Moore's Law and the 2-node cadence of fab costs... Herein lies a new semiconductor business model challenge that Pat Gelsinger sees: not only are the technologies different, the companies that make them have different core strengths that can't be easily duplicated. The fracturing of the industry's business model was originally driven by dual challenges of the rising density and the cost of a fab... So is this

truly a process of decadal cadence? I'll let you can make that judgement. What I do know is the causal nature of its driving forces is the same... As for Intel... the term 'systems foundry' is far clearer, as it implies a foundry to make systems, which can be easily laid out as done above...

Maxims: Problems are markets and solutions are products. One of the biggest mistakes companies make in product development is in not understanding this principle. You see it all the time, with marketing professionals foolishly referring to their product as a solution, when there is no problem that it comes close to solving. When they fail, the cliché used is often, "it was a solution in search of a market." But this misses mark. Obviously the developers must have thought …

For Your Reference: Now you have a chance to see me. I have accepted an invitation to speak at the NIST colloquium series Friday, September 16th, 2022, 8 AM PT/11 AM ET.

"If you don't like what's being said, change the conversation" — Don Draper, Mad Men

TechInsights

Contact us to get the full report and more

THE CHIP HISTORY CENTER

The Virtual Museum of Semiconductors

People: Yan Borodovsky discusses what was happening

in 2007 with DFM and Computational Lithography at Intel in this historic interview series. Intel had made quite a splash with its announcement that it had developed a new form of computational lithography. At the time, Dr. Borodovsky was a Senior Intel Fellow and Director of Advanced Lithography there. In the first video,



he describes the technology. In the second, he demonstrates how it works. In the third, details how innovation really happens at companies like Intel.

DFM and Computational Lithography

Yan Borodovsky demonstrates it

Breaking the Limits, Solving the Unsolvable



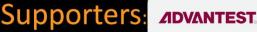
People: Craig Barrett discusses how Intel turned

manufacturing into the powerhouse it is today, in the first of this series with Dr. Barrett from 2006. He describes the origins of manufacturing lore such as Copy Exactly, Intel U, and **refsnart** in this interview. Then he also discusses the future of American competitive-



ness and the importance of math and science. At the time, he was Chairman of Intel.

How Intel Rebuilt Manufacturing in the mid-80's American Competitiveness Math, Science, and Your Future











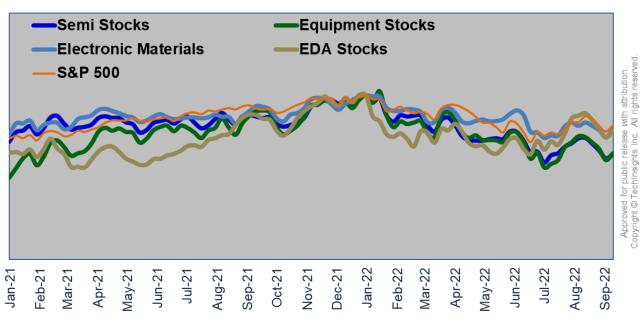




semiStockWEEK: TechInsights' Semiconductor Stock Indices and the S&P 500 jumped this week after falling the previous three weeks.

Semiconductor Industry Stock Performance Indices

(Stock Prices Indexed to 100 in last week of 2021)



TechInsights' Stock Indices:

Semiconductors +3.2% Equipment +4.9% Electronic Materials +4.6% EDA +4.2%





Semiconductor Stocks: Weekly Growth and Forward P/E Ratios by Company

Weekly Gains 9/9/2022									
Semiconductor Stocks	Price Change	Forward P/E	Semiconductor Stocks	Price Change	Forward P/E				
IDM			Fab-lite to Fabless						
Intel	0.8%	12	AMD	6.5%	16				
Micron	2.0%	14	Analog Devices	3.7%	16				
ON Semiconductor	6.2%	14	Broadcom	4.4%	12				
Samsung Electronics	-3.3%	-	IBM	1.1%	13				
SK hynix	-1.4%		Infineon	6.3%	11				
STMicroelectronics	7.3%	10	MagnaChip Semiconductor	0.3%	15				
Western Digital	5.2%	7	MaxLinear	5.7%	8				
Foundry & OSAT			MediaTek	0.5%	_				
Amkor	2.2%	6	NVIDIA	5.4%	22				
ASE	4.2%	6	Panasonic	-0.8%	11				
GLOBALFOUNDRIES	4.0%	24	Qualcomm	2.8%	10				
JCET	0.8%	14	Silicon Laboratories	10.2%	28				
SkyWater Technology	-9.5%		Skyworks	4.3%	8				
SMIC	6.3%	10	Texas Instruments	4.7%	18				
TSMC	0.8%	13			18				
UMC	0.2%	7							

TechInsights' Semiconductor Stock

Index was led up by Silicon Laboratories, getting a boost from the optimistic outlook for their 3Q22 earnings, STMicroelectronics was also a top performer this week.

IDM +2.4% Foundry & OSAT +1.1% Fabless & Fablite +3.9%

AMD AMD Analog Devices^{ADI} Amkor^{AMKR} ASE ASX Broadcom ^{AVGO} GLOBALFOUNDRIES ^{GFS} IBM ^{IBM} Infineon ^{IFNNY.PK} Intel ^{INTC} JCET^{600584.SS} Micron Technology ^{MU} On Semiconductor ^{ON} Panasonic ^{PC} MagnaChip Semiconductor ^{MX} MaxLinear ^{MXL} MediaTek ^{2454.TW} NVIDIA ^{NVDA} Qualcomm ^{QCOM} Samsung Electronics ^{005930.KS} Silicon Laboratories ^{SLAB} SkyWater Technology^{SKYT} Skyworks^{SWKS} SMIC ^{SMI} STMicroelectronics^{STM} Texas Instruments ^{TXN} TSMC ^{TSM} UMC^{UMC} Western Digital ^{WDC}

Chip Equipment & Related Stocks: Weekly Growth and Forward P/E Ratios by Company

Weekly Gains		9/9/2					
Equipment Stocks	Price Change	Forward P/E	Equipment Stocks		Price nange	Forward P/E	
Wafer Fab:			Test:				
Applied Materials	5.8%	11	Advantest	1	.4%	-	
ASM International	9.0%	20	Teradyne	7	.0%	13	
ASML	7.2%	23	FormFactor	2	2.8%	16	
KLA	7.0%	14					
Lam Research	4.8%	12	Assembly:				
Onto Innovation	5.8%	_	BESI	1:	3.1%	_	
Nikon	-1.8%	_	Kulicke & Soffa	1	.7%	11	
TEL	0.9%	_	ASM Pacific Technology	C).6%		
Veeco Instruments	5.9%	10					
				Above Avg	Top 4-6	Top 1-	

TechInsights' Semiconductor Equipment Stock Index was led up by BESI, who was also this week's top performer. ASM International and ASML were top performing stocks as well.

WFE +5.0% Test +3.7% Assembly +5.1%

Applied Materials AMAT Advantest ATEYY ASM International ASMIY ASM Lithography ASML ASM Pacific ^{0522.HK} BE Semiconductor ^{BESIY.PK} FormFactor ^{FORM} KLA ^{KLAC} Kulicke & Soffa ^{KLIC} Lam Research ^{LRCX} Onto Innovation ^{ONTO} Nikon ⁷⁷³¹ Teradyne ^{TER} Tokyo Electron Limited ⁸⁰³⁵ Veeco VECO

Electronic Materials Stocks: Weekly Growth and Forward P/E Ratios by Company

Weekly Gains 9/9/2										
EDA & Electronic Materials Stocks	Price Change	E Forward P/E I FDA & Electronic Materials Stocks				Forward P/E				
EDA			DNP	2	.9%	_				
Cadence	3.9%	37	DuPont de Nemours	6	.6%	5				
Synopsys	2.9%	34	JSR		.6%	_				
Ansys	5.8%	29	Shin-Etsu	2	.4%	_				
Electronic Materials			SOITEC		.8%	_				
BASF	5.3%	2	Tokyo Ohka	1	.7%	_				
Entegris	12.2%	19								
			Abo	ve Avg	Top 4-6	6 Top 1-3				

TechInsights' EDA Stock Index was led up by Ansys.

TechInsights' Electronic Materials Stock Index was led up by Entegris, all companies finished the week in positive territory.

Ansys, Inc. ^{ANSS} BASF BASFY Entegris ^{ENTG} Cadence ^{CDNS} DNP ⁷⁹¹² DuPont ^{DD} JSR ⁴¹⁸⁵ Shin-Etsu ⁴⁰⁶³ SOITEC^{SOI,PA} Synopsys ^{SNPS} Tokyo Ohka ⁴¹⁸⁶



The Prior	TechInsights' Indices of Chip Industry Stocks				Weekly Growth			nies	Growth	n	wth	e of rth	500	000 th	
Week's Close	Semi Stocks	Equipment Stocks	Materials Stocks	EDA Stocks	Semi Stocks	Equipment Stocks	Materials Stocks	EDA Stocks	Companies Up	Max Gro	Companies Down	Min Growth	Range of Growth	S&P 5	S&P 500 Growth
04-Feb-22	90.2	87.3	92.3	81.5	3.5%	3.3%	-0.1%	2.3%	41	17.5%	-13	-4.3%	21.8%	94.4	1.6%
11-Feb-22	89.6	86.1	93.2	78.7	-0.7%	-1.4%	1.0%	-3.4%	20	10.6%	-33	-8.9%	19.5%	92.7	-1.8%
18-Feb-22	90.1	86.8	93.0	75.0	0.6%	0.8%	-0.2%	-4.7%	28	12.2%	-26	-7.0%	19.2%	91.2	-1.6%
25-Feb-22	90.1	87.5	91.9	82.5	0.0%	0.8%	-1.3%	9.9%	30	14.7%	-25	-9.5%	24.2%	92.0	0.8%
04-Mar-22	85.3	81.4	86.8	81.5	-5.3%	-6.9%	-5.5%	-1.2%	7	6.4%	-48	-18.6%	25.0%	90.8	-1.3%
11-Mar-22	82.1	79.7	87.1	76.9	-3.7%	-2.2%	0.3%	-5.7%	9	9.7%	-45	-11.1%	20.8%	88.2	-2.9%
18-Mar-22	87.9	90.3	92.7	83.7	7.1%	13.3%	6.5%	8.8%	53	31.3%	-2	-5.9%	37.2%	93.6	6.2%
25-Mar-22	89.1	91.8	94.0	82.9	1.3%	1.7%	1.3%	-0.9%	36	9.2%	-16	-5.5%	14.7%	95.3	1.8%
01-Apr-22	85.4	87.8	91.5	86.1	-4.2%	-4.3%	-2.6%	3.9%	5	5.0%	-50	-23.1%	28.1%	95.4	0.1%
08-Apr-22	80.1	81.9	87.1	82.3	-6.2%	-6.8%	-4.8%	-4.4%	2	5.5%	-53	-17.6%	23.1%	94.2	-1.3%
15-Apr-22	78.1	79.2	86.4	76.9	-2.5%	-3.3%	-0.9%	-6.6%	6	4.2%	-49	-10.9%	15.1%	92.2	-2.1%
22-Apr-22	77.8	80.5	87.4	75.2	-0.3%	1.6%	1.3%	-2.2%	30	9.3%	-25	-18.8%	28.1%	89.6	-2.8%
29-Apr-22	77.8	78.2	88.2	75.7	0.0%	-2.9%	0.9%	0.7%	22	21.1%	-32	-14.9%	36.0%	86.7	-3.3%
06-May-22	78.6	78.3	87.3	72.6	0.9%	0.1%	-1.0%	-4.1%	30	12.0%	-25	-11.7%	23.7%	86.5	-0.2%
13-May-22	79.0	78.1	87.5	71.4	0.5%	-0.1%	0.2%	-1.6%	28	8.2%	-25	-10.0%	18.2%	84.4	-2.4%
20-May-22	78.6	77.3	88.3	74.5	-0.5%	-1.1%	1.0%	4.3%	22	17.9%	-30	-7.7%	25.6%	81.9	-3.0%
27-May-22	82.3	81.9	90.9	78.7	4.8%	6.0%	2.9%	5.6%	48	30.3%	-7	-7.8%	38.1%	87.2	6.6%
03-Jun-22	82.1	82.0	92.6	78.9	-0.3%	0.1%	1.9%	0.3%	29	7.7%	-26	-4.6%	12.3%	86.2	-1.2%
10-Jun-22	77.8	77.3	90.3	73.8	-5.2%	-5.7%	-2.5%	-6.5%	6	9.7%	-49	-11.9%	21.6%	81.8	-5.1%
17-Jun-22	72.0	69.1	82.3	71.2	-7.5%	-10.6%	-8.9%	-3.6%	2	4.0%	-53	-17.3%	21.3%	77.1	-5.8%
24-Jun-22	72.5	72.1	82.0	77.8	0.8%	4.3%	-0.3%	9.3%	41	12.8%	-14	-19.4%	32.2%	82.1	6.4%
01-Jul-22	67.2	64.9	79.3	73.5	-7.3%	-10.1%	-3.3%	-5.6%	3	6.1%	-52	-20.1%	26.2%	80.3	-2.2%
08-Jul-22	70.7	66.6	80.5	77.5	5.2%	2.7%	1.5%	5.5%	47	20.5%	-7	-4.8%	25.3%	81.8	1.9%
15-Jul-22	71.7	68.5	80.3	75.8	1.4%	2.8%	-0.2%	-2.2%	32	10.1%	-21	-9.1%	19.2%	81.1	-0.9%
22-Jul-22	74.9	74.7	84.9	81.5	4.4%	9.1%	5.7%	7.5%	52	66.7%	-3	-8.3%	75.0%	83.1	2.5%
29-Jul-22	76.6	77.2	86.7	88.8	2.4%	3.3%	2.2%	9.0%	39	12.4%	-16	-9.9%	22.3%	86.7	4.3%
05-Aug-22	79.0	80.1	85.1	90.1	3.1%	3.8%	-1.9%	1.5%	47	33.8%	-8	-17.1%	50.9%	87.0	0.4%
12-Aug-22	79.2	79.6	86.8	91.2	0.3%	-0.6%	1.9%	1.3%	33	22.3%	-22	-17.4%	39.7%	89.8	3.3%
19-Aug-22	76.4	77.0	85.1	88.0	-3.6%	-3.3%	-1.9%	-3.6%	9	17.4%	-46	-8.1%	25.5%	88.7	-1.2%
26-Aug-22	73.1	74.0	83.1	83.9	-4.3%	-3.9%	-2.3%	-4.7%	2	1.1%	-53	-17.8%	18.9%	85.1	-4.0%
02-Sep-22	69.2	68.4	79.6	79.4	-5.4%	-7.5%	-4.1%	-5.4%	1	2.1%	-54	-16.1%	18.2%	82.3	-3.3%
09-Sep-22	71.4	71.8	83.3	82.7	3.2%	4.9%	4.6%	4.2%	50	13.1%	-5	-9.5%	22.6%	85.3	3.6%

Links to **Conference Call** Transcripts

September 9th

Western Digital Corporation (WDC) Presents at Evercore ISI 2nd Annual TMT Conference (Transcript)

ON Semiconductor Corporation (ON) Presents at Citi 2022 Global Technology Conference (Transcript)

ASML Holding NV (ASML) Citi 2022 Global Technology Conference (Transcript)

International Business Machines Corporation (IBM) Evercore ISI 2nd Annual Technology, Media & Telcom Conference 2022 Call Transcript

Analog Devices Inc. (ADI) 2022 Evercore ISI 2nd Annual Technology, Media & Telcom Conference (Transcript)

Applied Materials, Inc. (AMAT) Presents at Citi 2022 Global Technology Conference (Transcript)

Western Digital Corporation (WDC) Citi 2022 Global Technology Conference

NXP Semiconductors N.V. (NXPI) Presents at 2022 Citi's 2022 Global Technology Conference (Transcript)

Lam Research Corporation (LRCX) Management Presents at Evercore ISI 2nd Annual Technology, Media & Telcom Conference 2022 (Transcript)

TechInsights

Texas Instruments (TXN) Presents at Citigroup 2022 Global Technology Conference - Conference Call Transcript

September 2nd and before

Broadcom Inc. (AVGO) Q3 2022 Earnings Call Transcript

Micron Technology, Inc. (MU) Presents at Deutsche Bank 2022 Technology Conference (Transcript)

ON Semiconductor Corporation (ON) Deutsche Bank 2022 Technology Conference (Transcript)

Intel Corp (INTC) Deutsche Bank Technology Conference Transcript

Western Digital Corporation (WDC) Deutsche Bank 2022 Technology Conference (Transcript)

NVIDIA Corporation (NVDA) CEO Jensen Huang on Q2 2023 Results - Earnings Call Transcript

Links to Conference Call Transcripts

Applied Materials, Inc.'s (AMAT) CEO Gary Dickerson on Q3 2022 Results - Earnings Call Transcript Synopsys, Inc. (SNPS) CEO Aart de Geus on Q3 2022 Results - Earnings Call Transcript Analog Devices Inc. (ADI) CEO Vincent Roche on Q3 2022 Results - Earnings Call Transcript Agilent Technologies, Inc. (A) CEO Mike McMullen on Q3 2022 Results - Earnings Call Transcript SkyWater Technology, Inc. (SKYT) CEO Thomas Sonderman on Q2 2022 Results - Earnings Call Transcript Magnachip Semiconductor Corporation (MX) CEO YJ Kim on Q2 2022 Results - Earnings Call Transcript ACM Research, Inc. (ACMR) CEO David Wang on Q2 2022 Results - Earnings Call Transcript Western Digital Corporation (WDC) CEO David Goeckeler on Q4 2022 Results - Earnings Call Transcript Skyworks Solutions, Inc.'s (SWKS) CEO Liam Griffin on Q3 2022 Results - Earnings Call Transcript Kulicke and Soffa Industries, Inc. (KLIC) CEO Fusen Chen on Q3 2022 Results - Earnings Call Transcript Infineon Technologies AG (IFNNY) CEO Jochen Hanebeck on Q3 2022 Results - Earnings Call Transcript Advanced Energy Industries, Inc. (AEIS) CEO Stephen Kelley on Q2 2022 Results - Earnings Call Transcript Qorvo, Inc.'s (QRVO) CEO Bob Bruggeworth on Q1 2023 Results - Earnings Call Transcript Microchip Technology Incorporated's (MCHP) CEO Ganesh Moorthy on Q1 2023 Results - Earnings Call Transcript Advanced Micro Devices, Inc.'s (AMD) CEO Lisa Su on Q2 2022 Results - Earnings Call Transcript Cirrus Logic, Inc.'s (CRUS) CEO John Forsyth on Q1 2023 Results - Earnings Call Transcript Amkor Technology, Inc. (AMKR) CEO Giel Rutten on Q2 2022 Results - Earnings Call Transcript ON Semiconductor Corporation's (ON) CEO Hassane El-Khoury on Q2 2022 Results - Earnings Call Transcript SK Hynix, Inc.'s (HXSCF) Q2 2022 Results - Earnings Call Transcript

Links to **Conference Call** Transcripts

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